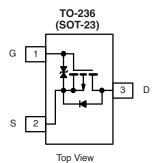




P-Channel 30-V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	$R_{DS(on)}(\Omega)$	V _{GS(th)} (V)	I _D (mA)	Q _g (Typ.)				
- 30	1.4 at V _{GS} = - 10 V	- 1.3 to - 3.0	- 385	1000				
	$3.5 \text{ at V}_{GS} = -4.5 \text{ V}$	- 1.3 to - 3.0	- 240	1000				



Marking Code: 2Kwll

2K = Part Number Code for TP0202K

w = Week Code

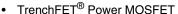
ll = Lot Traceability

Ordering Information: TP0202K-T1-E3 (Lead (Pb)-free)

TP0202K-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

 Halogen-free According to IEC 61249-2-21 Available



High-Side Switching

• Low On-Resistance: 1.2 Ω (typ.)

• Low Threshold: - 2 V (typ.)

Fast Swtiching Speed: 14 ns (typ.)Low Input Capacitance: 31 pF (typ.)

• 2000 V ESD Protection

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- · Battery Operated Systems
- Power Supply Converter Circuits
- · Solid-State Relays

BENEFITS

- · Ease in Driving Switches
- Low Offset (Error) Voltage
- · Low-Voltage Operation
- High-Speed Circuits
- · Easily Driven without Buffer

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter		Symbol	Limit	Unit			
Drain-Source Voltage		V_{DS}	- 30	V			
Gate-Source Voltage		V_{GS}	± 20	V			
Continuous Dusis Courset /T 150 °C\8	T _A = 25 °C	I_	- 385	mA			
Continuous Drain Current (T _J = 150 °C) ^a	T _A = 85 °C	lD	- 280				
Pulsed Drain Current ^b		I _{DM}	- 750	ı			
Down Distinction	T _A = 25 °C	P _D	350	mW			
Power Dissipation ^a	T _A = 85 °C	' D	185	11100			
Maximum Junction-to-Ambient ^a		R _{thJA}	350	°C/W			
Operating Junction and Storage Temperature Range		T _{J,} T _{stg}	- 55 to 150	°C			

Notes:

- a. Surface Mounted on FR4 board.
- b. Pulse width limited by maximum junction temperature.

RoHS COMPLIANT HALOGEN

FREE

TP0202K

Vishay Siliconix



	°C, unless othe	Test Conditions	Limits				
Parameter			Min.	Тур.	Max.	Unit	
Static			I		L	1	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = -100 \mu\text{A}$	- 30	- 38		V	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.3	- 2	- 3.0	v	
Cata Bady Laglaga	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 5 \text{ V}$			± 50	nA	
Gate-Body Leakage		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 10 \text{ V}$			± 300		
Zara Cata Valtaria Duain Current	I _{DSS}	V _{DS} = - 30 V, V _{GS} = 0 V			- 100		
Zero Gate Voltage Drain Current		V _{DS} = - 30 V, V _{GS} = 0 V, T _J = 85 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = - 10 V, V _{DS} = - 10 V	- 500			mA	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 50 mA		2.1	3.5	Ω	
Drain-Source On-Resistance ^a		V _{GS} = - 10 V, I _D = - 500 mA		1.25	1.4		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 5 V, I _D = - 200 mA		315		mS	
Diode Forward Voltage ^a	V _{SD}	I _S = - 250 mA, V _{GS} = 0 V			- 1.2	V	
Dynamic	-		•	I.			
Total Gate Charge	Q_g	V 16 V V 10 V		1000		pC	
Gate-Source Charge	Q _{gs}	$V_{DS} = -16 \text{ V}, V_{GS} = -10 \text{ V}$ $I_{D} \cong -200 \text{ mA}$		225			
Gate-Drain Charge	Q _{gd}	10 = -200 mA		175			
Input Capacitance	C _{iss}	V 45.V.V 6.V		31		pF	
Output Capacitance	C _{oss}	$V_{DS} = -15 \text{ V}, V_{GS} = 0 \text{ V}$ f = 1 MHz		11			
Reverse Transfer Capacitance	C _{rss}	1 – 1 WILLS		4			
Switching ^b	•		•				
Turn On Time	t _{d(on)}	V _{DD} = - 15 V, R _L = 75 Ω		9		- ns	
Turn-On Time	t _r			6			
Turn Off Time	t _{d(off)}	$I_D \cong$ - 200 mA, V_{GEN} = - 10 V, R_G = 6 Ω		30			
Turn-Off Time	t _f			20			

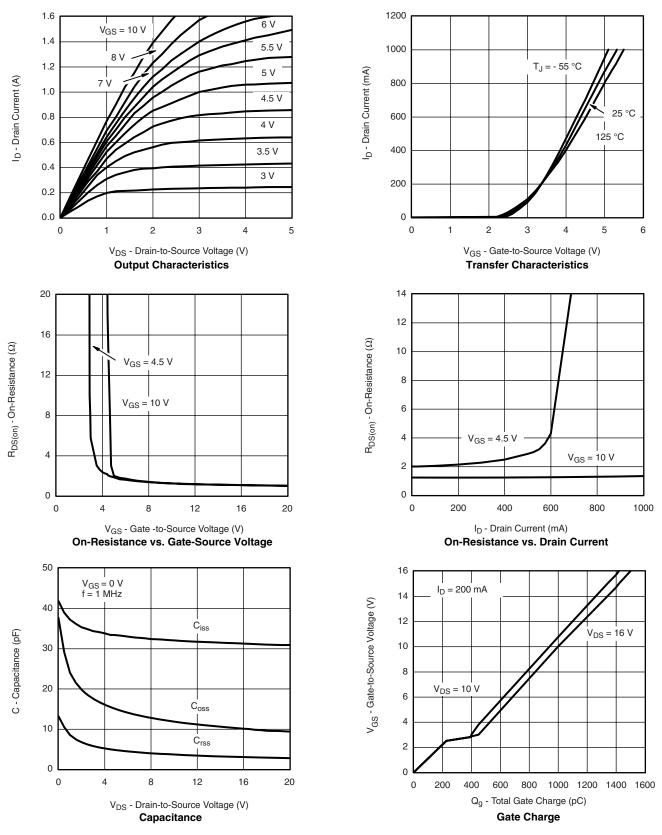
Notes:

- a. Pulse test: PW \leq 300 μs duty cycle \leq 2 %.
- b. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



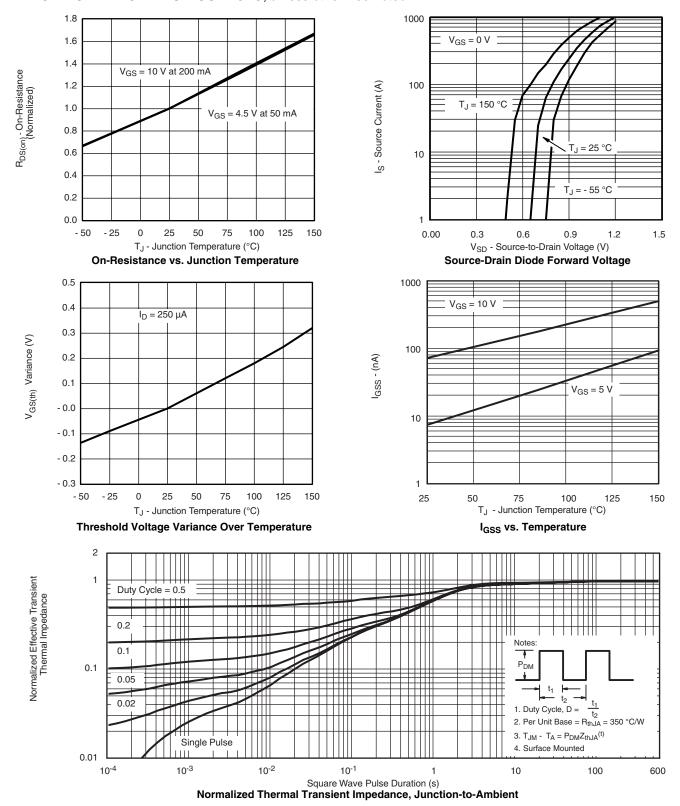
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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